

SUPPLY-CHAIN PERFORMANCE WORKING GROUP MINUTES

Date: August 31, 2009

Location: Teleconference

Time: 1:00pm (Pacific)

Participants:

Chelsea Boone – GSA
Dan Wark – Amalfi Semiconductor Inc.
Roger DeAmicis – ChipX
Ed Pausa – PricewaterhouseCoopers LLP
Antonio Lopes – Brocade
Eelco Bergman – Vietnam - Chipscale Advanced Packaging Services
Feng Li – Parade Technologies, Inc.
Larry Sladewski – NVIDIA
Vinayak Gupta – RMI Corporation

Meeting Purpose:

- To discuss the Q3 2009 Wafer & Back-End Pricing Survey Results.

Actions Completed/Items Discussed:

- Q3 2009 WP & BE Survey Results
- Future Timelines/Dates for Next Survey

End Result/Conclusions:

- **Q3 2009 WP & BE Survey Results:**
 - Assembly
 - Delete lines 13 & 14 in spreadsheet. Verify units per week with participant for line 13.
 - Lines 5,7,8,18 are okay.
 - Verify line 11.
 - Wafer
 - Delete lines 5,8-13
 - Keep lines 2-4,6-7,14-18
 - Mask
 - Delete line 3
 - Lines 2,4,5,6 are okay.
- PDS needs to attend every supply chain working group meeting.
- Need to find out from PDS if they are providing the exact questions and answers each time they verify a data point with the participant.
- **Future Timelines/Dates for Next Survey:**
 - Q3 2009 Wafer & Back-End Pricing Report Released: End of Sept 09
 - Q4 2009 Wafer & Back-End Pricing Survey Released: Week of 10/12
 - Q4 2009 Wafer & Back-End Pricing Survey Ends: Week of 11/9
 - Q4 2009 Working Group Meeting to discuss Q4 09 results: Week of 11/23